

East % USPB, USPT

L Number	Hits	Search Text	DB	Time stamp
1	147576	solder\$	USPAT; US-PGPUB	2004/10/02 16:49
2	28463	bond\$ with pad	USPAT; US-PGPUB	2004/10/02 16:49
3	5612	solder\$ same (bond\$ with pad)	USPAT; US-PGPUB	2004/10/02 16:49
4	1124	((solder\$ same (bond\$ with pad)) same adhes\$	USPAT; US-PGPUB	2004/10/02 16:52
5	0	"adhes\$ layer"	USPAT; US-PGPUB	2004/10/02 16:53
6	145835	adhes\$ with layer	USPAT; US-PGPUB	2004/10/02 16:53
7	374	((solder\$ same (bond\$ with pad)) same adhes\$) same (adhes\$ with layer)	USPAT; US-PGPUB	2004/10/02 16:53